

AGENDA

P-2.5 COMMITTEE FOR TANTALUM & NIOBIUM CAPACITORS

WEDNESDAY, September 26, 2007

2:00 to 4:00 PM

San Antonio, TX

1. **COMMITTEE ORGANIZATION AND PROCEDURES**
 - 1.1 Membership and attendance
 - 1.2 Review and approve agenda
 - 1.3 Approve minutes of last meeting, San Diego, April 18, 2007
 - 1.4 Correspondence
2. **OLD BUSINESS**
 - 2.1 Reports
 - 2.1.1 Passive Component Steering Committee (S.1).....Mike Lauri
(Announcement of future meeting dates and locations)
 - 2.1.2 Government Specifications and Standards..... DSCC Representative
 - 2.2 Surface Mount Tantalum Capacitors
 - 2.1 Status: Standard (EIA-535BAAC),
 - 2.1.2 Discussion of new case sizes, ratings, or products....All Members
 - 2.2.2.1 Lead-frame less/face down termination molded specification?
 - 2.3 AEC Q 200 Preconditioning DOE project
 - 2.4.1 Lead free solder topics - Tin Whiskers.....China RoHS update
 - 2.5 Update EIA 809 Tantalum Applications Guide
 - 2.6.1 Review existing specifications: J-Std-020C, IPC-9503 (MSL passives), IPC-9504 (Assembly Process Simulation for Non-IC Devices)
 - 2.7 Review and update EIA list of "active working projects"
 - 2.8 Review Niobium/NbO draft specification/ PN number 5075
 - 2.9 Update EIA IS 717 Qualification specification number PN 5097
3. **NEW BUSINESS**
 - 3.1.1 Discuss addition of Aluminum Polymer caps to committee business
 - 3.2 Inputs for "All-Chairs Meeting"
4. **ADJOURNMENT**